

HIGH VOLTAGE SILICON POWER TRANSISTOR

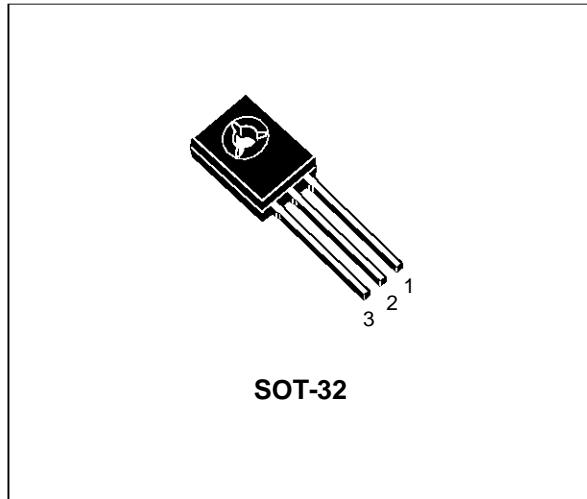
- SGS-THOMSON PREFERRED SALESTYPES
- NPN TRANSISTOR
- HIGH VOLTAGE CAPABILITY (450V V_{CEO})
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- HIGH DC CURRENT GAIN

APPLICATIONS:

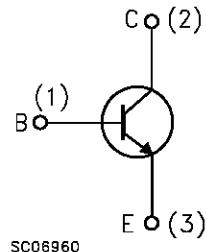
FLYBACK AND FORWARD SINGLE TRANSISTOR LOW POWER CONVERTERS

DESCRIPTION

The BUX87 is manufactured using High Voltage Multi Epitaxial Planar technology for high switching speeds and high voltage withstand capability.



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage ($V_{BE} = -1.5V$)	1000	V
V _{CEO}	Collector-Emitter Voltage ($I_B = 0$)	450	V
V _{EBO}	Emitter-Base Voltage ($I_C = 0$)	5	V
I _C	Collector Current	0.5	A
I _{CM}	Collector Peak Current ($t_p < 5 \text{ ms}$)	1	A
I _B	Base Current	0.3	A
I _{BM}	Base Peak Current ($t_p < 5 \text{ ms}$)	0.6	A
P _{tot}	Total Dissipation at $T_c = 25^\circ\text{C}$	40	W
T _{stg}	Storage Temperature	-65 to 150	°C
T _j	Max. Operating Junction Temperature	150	°C

BUX87

THERMAL DATA

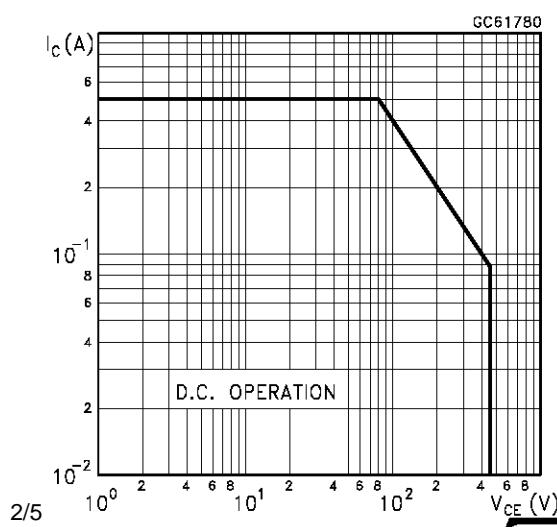
R _{thj-case}	Thermal Resistance Junction-case	Max	3.12	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max	100	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ °C unless otherwise specified)

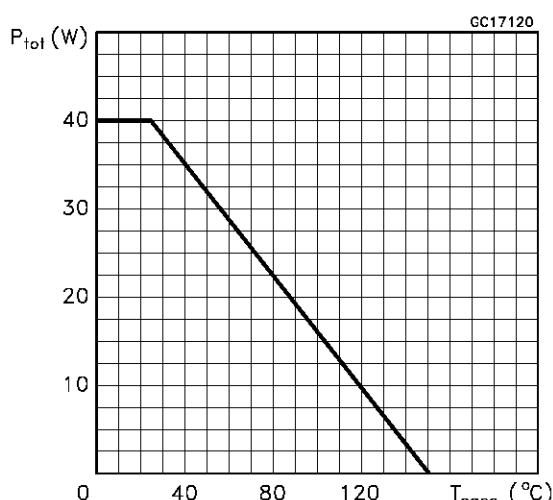
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I _{CEV}	Collector Cut-off Current ($V_{BE} = -1.5V$)	$V_{CE} = 1000$ V $V_{CE} = 1000$ V $T_j = 125$ °C			100 1	μA mA
I _{EBO}	Emitter Cut-off Current ($I_c = 0$)	$V_{EB} = 5$ V			1	mA
V _{C EO(sus)}	Collector-Emitter Sustaining Voltage	$I_c = 100$ mA	450			V
V _{B EO}	Collector-Base Sustaining Voltage	$I_c = 10$ mA	5			V
V _{CE(sat)*}	Collector-Emitter Saturation Voltage	$I_c = 0.1$ A $I_B = 0.01$ A $I_c = 0.2$ A $I_B = 0.02$ A			0.8 1	V V
V _{BE(sat)*}	Base-Emitter Saturation Voltage	$I_c = 0.2$ A $I_B = 0.02$ A			1	V
h_{FE}^*	DC Current Gain	$I_c = 50$ mA $V_{CE} = 5$ V $I_c = 40$ mA $V_{CE} = 5$ V	12	50		
f _T	Transition Frequency	$I_c = 50$ mA $V_{CE} = 10$ V f=1MHz		20		MHz
t _s t _f	RESISTIVE LOAD Storage Time Fall Time	$V_{CC} = 250$ V $I_c = 200$ mA $I_{B1} = 40$ mA $I_{B2} = -80$ mA $t_p = 20$ μs			4.5 0.5	μs μs

* Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

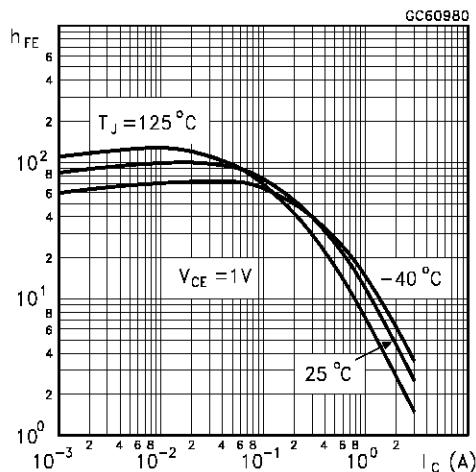
Safe Operating Area



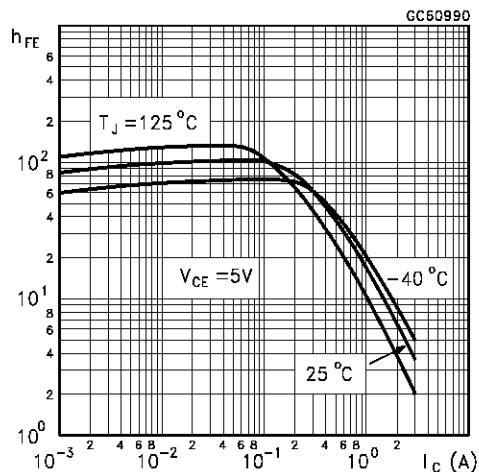
Derating Curves



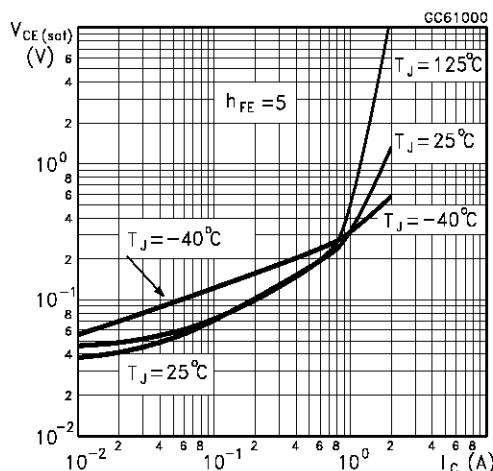
DC Current Gain



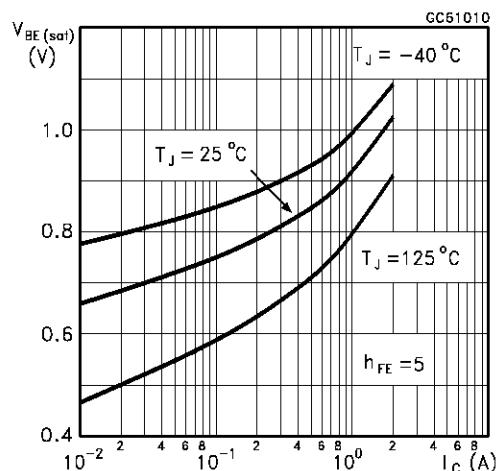
DC Current Gain



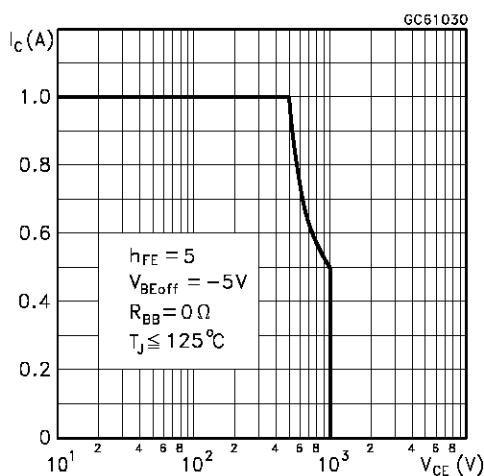
Collector Emitter Saturation Voltage



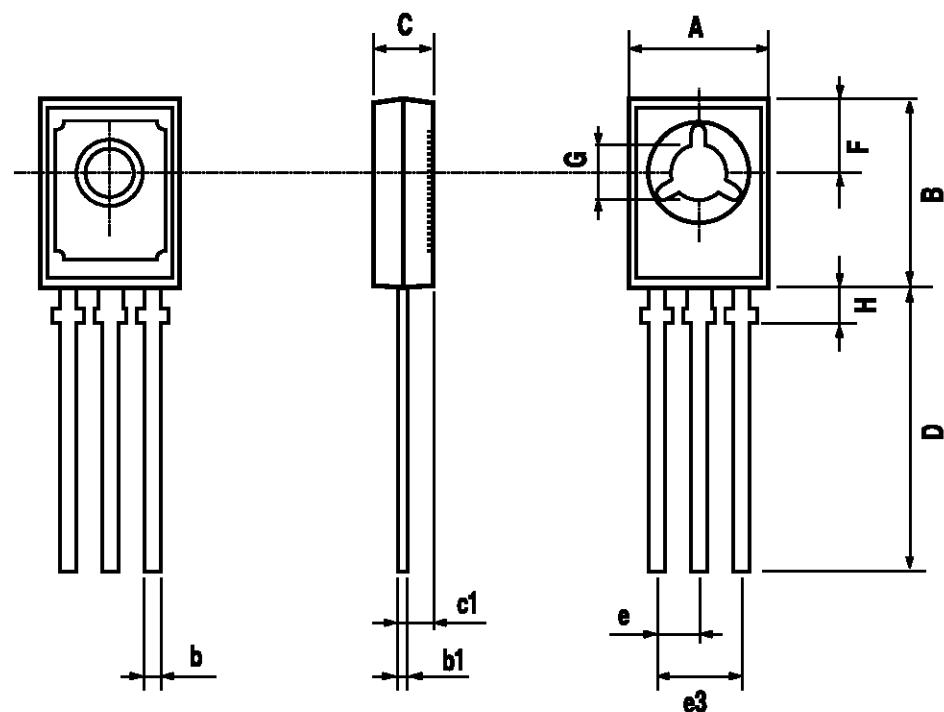
Base Emitter Saturation Voltage



Reverse Biased SOA



SOT-32 MECHANICAL DATA						
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	7.4		7.8	0.291		0.307
B	10.5		10.8	0.413		0.445
b	0.7		0.9	0.028		0.035
b1	0.49		0.75	0.019		0.030
C	2.4		2.7	0.04		0.106
c1		1.2			0.047	
D		15.7			0.618	
e		2.2			0.087	
e3		4.4			0.173	
F		3.8			0.150	
G	3		3.2	0.118		0.126
H			2.54			0.100



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